

## AMENDMENTS TO THE CLAIMS

**Claim 1. (Currently Amended)** A modified polyoxyalkylene polyamine ~~obtainable~~ obtained by addition reaction of a polyoxyalkylene polyamine and an ~~alkenyl group-~~ containing unsaturated hydrocarbon compound.

**Claim 2. (Original)** The modified polyoxyalkylene polyamine according to Claim 1, wherein said polyoxyalkylene polyamine has a weight average molecular weight of not more than 1000.

**Claim 3. (Currently Amended)** The modified polyoxyalkylene polyamine according to Claim 1, wherein a the carbon number of said alkenyl group-containing compound is 2 to 16.

**Claim 4. (Currently Amended)** The modified polyoxyalkylene polyamine according to Claim 2, wherein a the carbon number of said alkenyl group-containing compound is 2 to 16.

**Claim 5. (Original)** The modified polyoxyalkylene polyamine according to Claim 3, wherein said alkenyl group-containing compound is styrene.

**Claim 6. (Original)** The modified polyoxyalkylene polyamine according to Claim 4, wherein said alkenyl group-containing compound is styrene.

**Claim 7. (Currently Amended)** The modified polyoxyalkylene polyamine according to Claim 1, wherein a the molar number of modification of said polyoxyalkylene polyamine by said alkenyl group-containing compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \leq X \leq A \quad (1)$$

wherein "A" represents a the number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents a the molar number of modification.

**Claim 8. (Original)** The modified polyoxyalkylene polyamine according to Claim 2, wherein a molar number of modification of said polyoxyalkylene polyamine by said alkenyl group-containing compound satisfies the following mathematical formula (1).

$$\frac{1}{10} A \leq X \leq A \quad (1)$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents a molar number of modification.

**Claim 9. (Original)** The modified polyoxyalkylene polyamine according to Claim 3, wherein a molar number of modification of said polyoxyalkylene polyamine by said alkenyl group-containing compound satisfies the following mathematical formula (1).

$$\frac{1}{10} A \leq X \leq A \quad (1)$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents a molar number of modification.

**Claim 10. (Original)** The modified polyoxyalkylene polyamine according to Claim 5, wherein a molar number of modification of said polyoxyalkylene polyamine by said alkenyl group-containing compound satisfies the following mathematical formula (1).

$$\frac{1}{10} A \leq X \leq A \quad (1)$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents a molar number of modification.

**Claim 11. (Original)** The modified polyoxyalkylene polyamine according to Claim 6, wherein a molar number of modification of said polyoxyalkylene polyamine by said alkenyl group-containing compound satisfies the following mathematical formula (1).

$$\frac{1}{10}A \leq X \leq A \quad (1)$$

wherein "A" represents a number of active hydrogen atoms in said polyoxyalkylene polyamine and "X" represents a molar number of modification.

**Claim 12. (Original)** A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 1.

**Claim 13. (Original)** A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 2.

**Claim 14. (Original)** A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 3.

**Claim 15. (Original)** A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 5.

**Claim 16. (Original)** A curing agent for epoxy resin comprising the modified polyoxyalkylene polyamine according to Claim 6.

**Claim 17. (Withdrawn)** An epoxy resin composition comprising an epoxy resin and the curing agent for epoxy resin according to Claim 12.

**Claim 18. (Withdrawn)** An epoxy resin cured product obtainable by curing the epoxy resin composition according to Claim 17.